

MP6901

High Power Switching Applications
Hammer Drive, Pulse Motor Drive and Inductive Load Switching

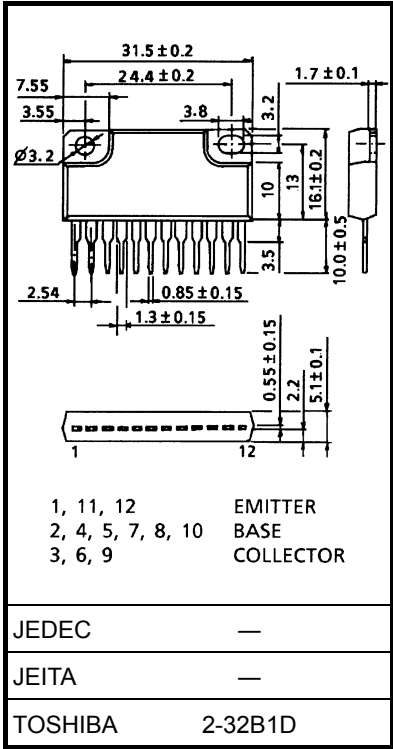
- Package with heat sink isolated to lead (SIP 12 pins)
- High collector power dissipation (6-device operation)
: $P_T = 5\text{ W}$ ($T_a = 25^\circ\text{C}$)
- High collector current: $I_C\text{ (DC)} = \pm 4\text{ A (max)}$
- High DC current gain: $h_{FE} = 2000\text{ (min)}$ ($V_{CE} = \pm 2\text{ V}$, $I_C = \pm 1\text{ A}$)

Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics		Symbol	Rating		Unit
			NPN	PNP	
Collector-base voltage		V _{CBO}	100	−100	V
Collector-emitter voltage		V _{CEO}	80	−80	V
Emitter-base voltage		V _{EBO}	5	−5	V
Collector current		I _C	4	−4	A
		I _{CP}	6	−6	
Continuous base current		I _B	0.4	−0.4	A
Collector power dissipation (1-device operation)		P _C	3.0		W
Collector power dissipation (6-device operation)	T _a = 25°C	P _T	5.0		W
	T _c = 25°C		25		
Isolation voltage		V _{Isol}	1000		V
Junction temperature		T _j	150		°C
Storage temperature range		T _{stg}	−55 to 150		°C

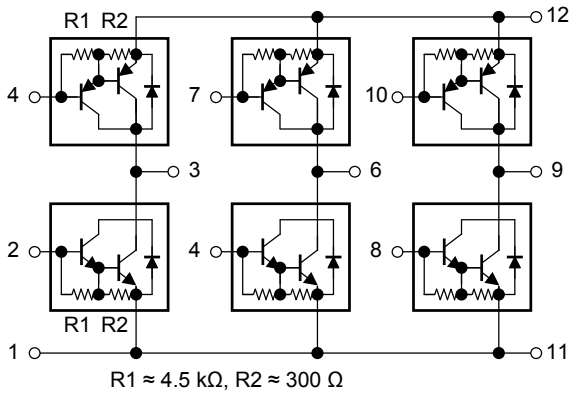
Industrial Applications

Unit: mm

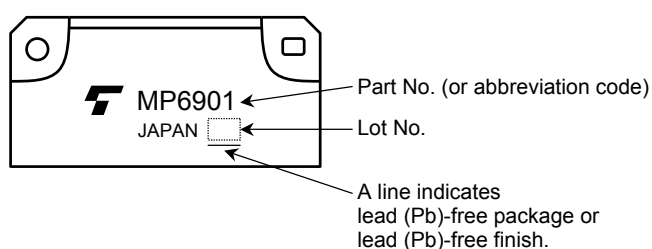


Weight: 6.0 g (typ.)

Array Configuration



Marking



Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance from junction to ambient (6-device operation, $T_a = 25^\circ\text{C}$)	$\Sigma R_{th(j-a)}$	25	$^\circ\text{C/W}$
Thermal resistance from junction to case (6-device operation, $T_c = 25^\circ\text{C}$)	$\Sigma R_{th(j-c)}$	5.0	$^\circ\text{C/W}$
Maximum lead temperature for soldering purposes (3.2 mm from case for 10 s)	T_L	260	$^\circ\text{C}$

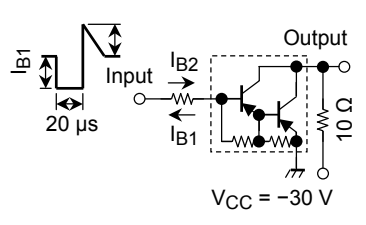
Electrical Characteristics ($T_a = 25^\circ\text{C}$) (NPN transistor)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current		I_{CBO}	$V_{CB} = 100\text{ V}, I_E = 0\text{ A}$	—	—	20	μA
Collector cut-off current		I_{CEO}	$V_{CE} = 80\text{ V}, I_B = 0\text{ A}$	—	—	20	μA
Emitter cut-off current		I_{EBO}	$V_{EB} = 5\text{ V}, I_C = 0\text{ A}$	0.5	—	2.5	mA
Collector-base breakdown voltage		$V_{(BR)CBO}$	$I_C = 1\text{ mA}, I_E = 0\text{ A}$	100	—	—	V
Collector-emitter breakdown voltage		$V_{(BR)CEO}$	$I_C = 10\text{ mA}, I_B = 0\text{ A}$	80	—	—	V
DC current gain		$h_{FE(1)}$	$V_{CE} = 2\text{ V}, I_C = 1\text{ A}$	2000	—	—	—
		$h_{FE(2)}$	$V_{CE} = 2\text{ V}, I_C = 3\text{ A}$	1000	—	—	
Saturation voltage	Collector-emitter	$V_{CE(sat)}$	$I_C = 3\text{ mA}, I_B = 6\text{ mA}$	—	—	1.5	V
	Base-emitter	$V_{BE(sat)}$	$I_C = 3\text{ mA}, I_B = 6\text{ mA}$	—	—	2.0	
Transition frequency		f_T	$V_{CE} = 2\text{ V}, I_C = 0.5\text{ A}$	—	60	—	MHz
Collector output capacitance		C_{ob}	$V_{CB} = 10\text{ V}, I_E = 0\text{ A}, f = 1\text{ MHz}$	—	35	—	pF
Switching time	Turn-on time	t_{on}	$I_{B1} = -I_{B2} = 6\text{ mA}, \text{ duty cycle } \leq 1\%$	—	0.2	—	μs
	Storage time	t_{stg}		—	1.5	—	
	Fall time	t_f		—	0.6	—	

Emitter-Collector Diode Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Forward current	I_{FM}	—	—	—	4	A
Surge current	I_{FSM}	$t = 1 \text{ s}, 1 \text{ shot}$	—	—	6	A
Forward voltage	V_F	$I_F = 1 \text{ A}, I_B = 0 \text{ A}$	—	—	2.0	V
Reverse recovery time	t_{rr}	$I_F = 4 \text{ A}, V_{BE} = -3 \text{ V}, dI_F/dt = -50 \text{ A}/\mu\text{s}$	—	1.0	—	μs
Reverse recovery charge	Q_{rr}		—	8	—	μC

Electrical Characteristics (Ta = 25°C) (PNP transistor)

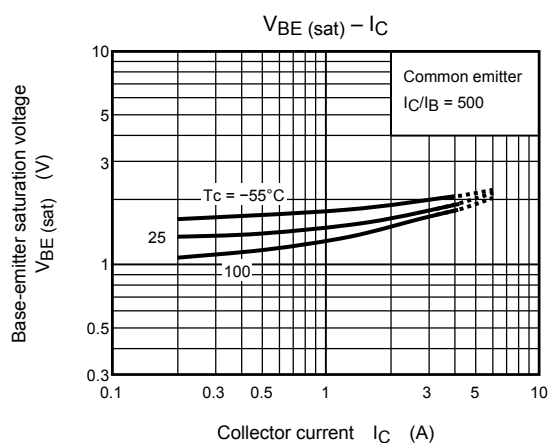
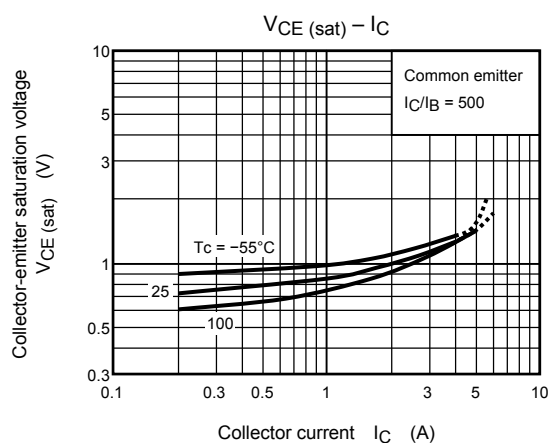
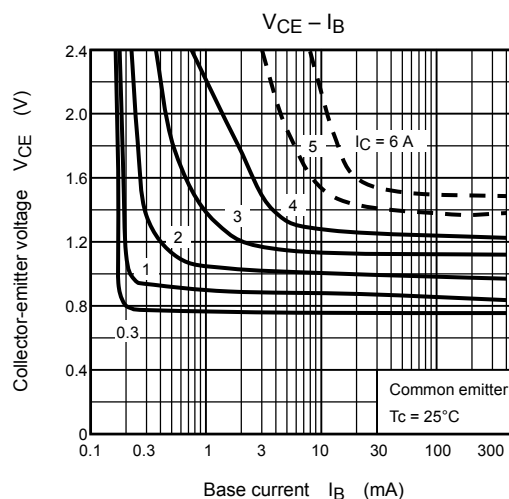
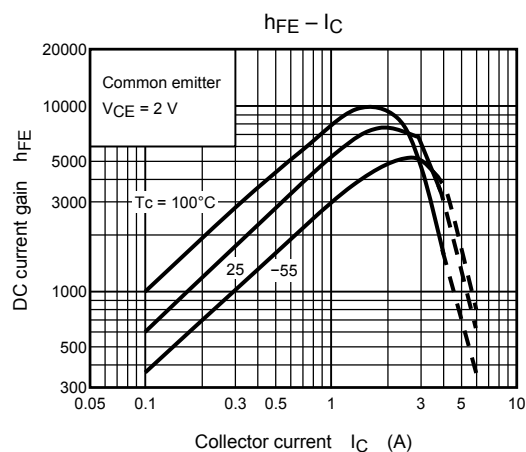
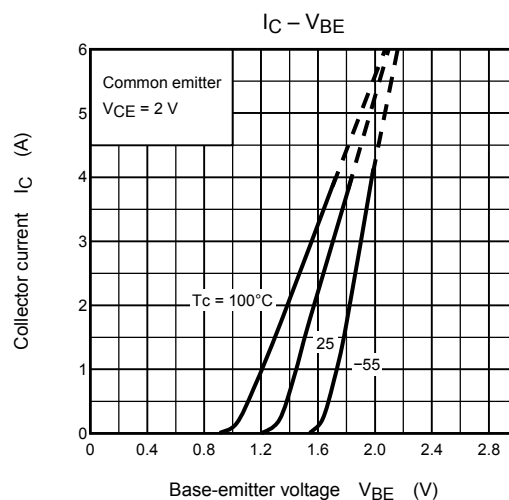
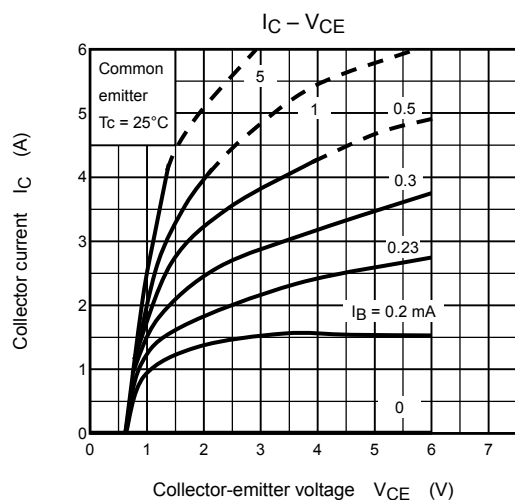
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current	I_{CBO}	$V_{CB} = -100 \text{ V}, I_E = 0 \text{ A}$	—	—	-20	μA
Collector cut-off current	I_{CEO}	$V_{CE} = -80 \text{ V}, I_B = 0 \text{ A}$	—	—	-20	μA
Emitter cut-off current	I_{EBO}	$V_{EB} = -5 \text{ V}, I_C = 0 \text{ A}$	-0.5	—	-2.5	mA
Collector-base breakdown voltage	$V_{(BR) CBO}$	$I_C = -1 \text{ mA}, I_E = 0 \text{ A}$	-100	—	—	V
Collector-emitter breakdown voltage	$V_{(BR) CEO}$	$I_C = -10 \text{ mA}, I_B = 0 \text{ A}$	-80	—	—	V
DC current gain	$h_{FE} (1)$	$V_{CE} = -2 \text{ V}, I_C = -1 \text{ A}$	2000	—	—	—
	$h_{FE} (2)$	$V_{CE} = -2 \text{ V}, I_C = -3 \text{ A}$	1000	—	—	
Saturation voltage	Collector-emitter	$V_{CE} (\text{sat})$	$I_C = -3 \text{ A}, I_B = -6 \text{ mA}$	—	-1.5	V
	Base-emitter	$V_{BE} (\text{sat})$	$I_C = -3 \text{ A}, I_B = -6 \text{ mA}$	—	-2.0	
Transition frequency	f_T	$V_{CE} = -2 \text{ V}, I_C = -0.5 \text{ A}$	—	40	—	MHz
Collector output capacitance	C_{ob}	$V_{CB} = -10 \text{ V}, I_E = 0 \text{ A}, f = 1 \text{ MHz}$	—	60	—	pF
Switching time	Turn-on time	t_{on}		0.15	—	μs
	Storage time	t_{stg}		0.80	—	
	Fall time	t_f		0.40	—	

$-I_{B1} = I_{B2} = 6 \text{ mA}, \text{ duty cycle} \leq 1\%$

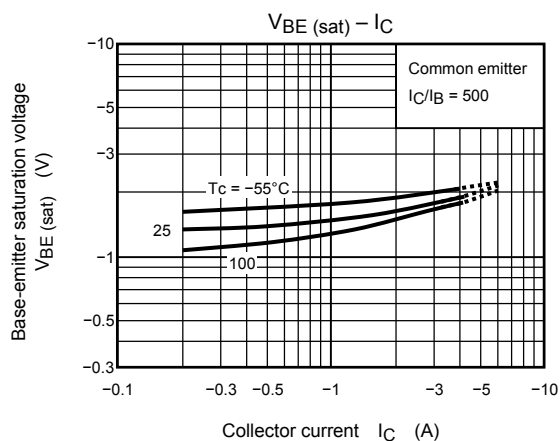
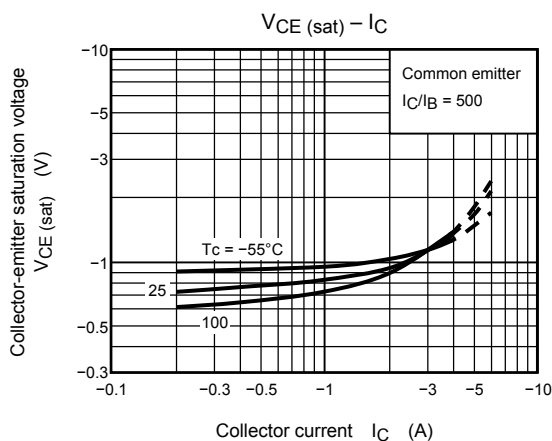
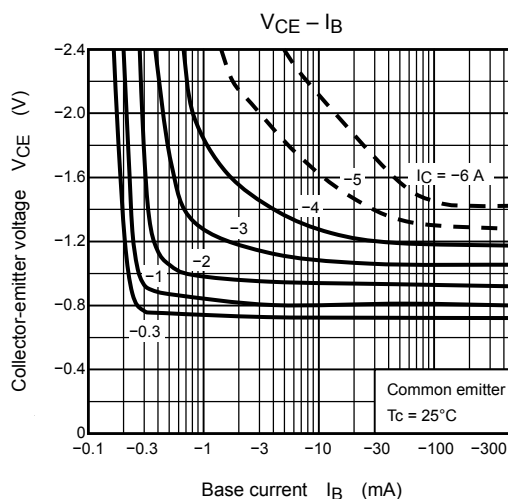
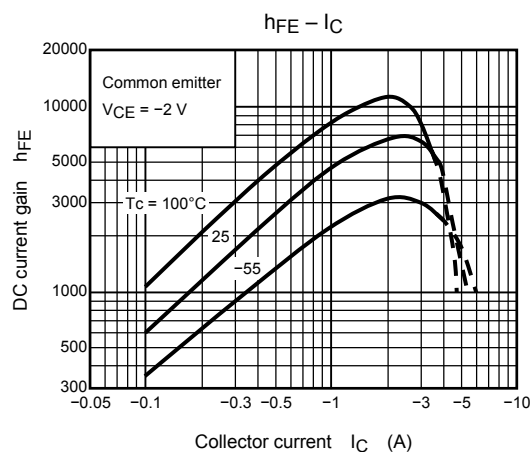
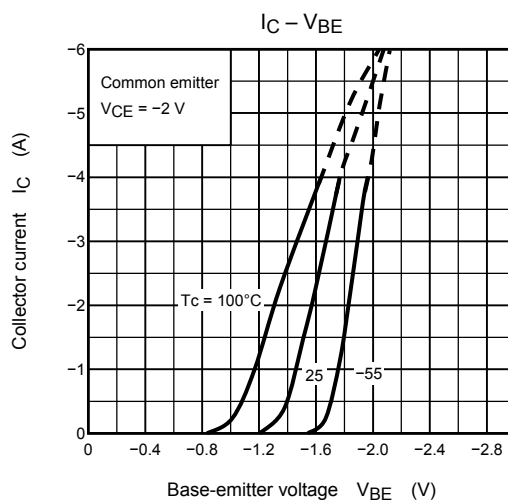
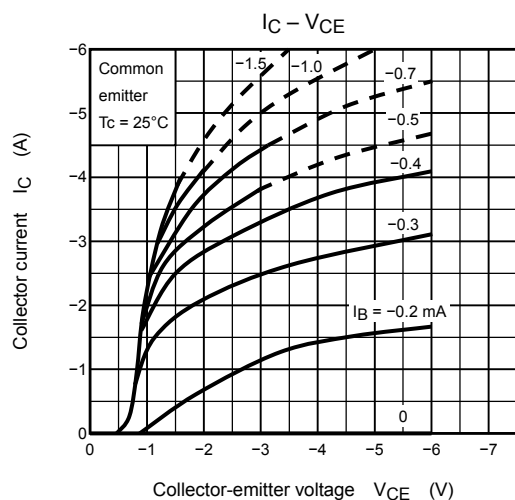
Emitter-Collector Diode Ratings and Characteristics (Ta = 25°C)

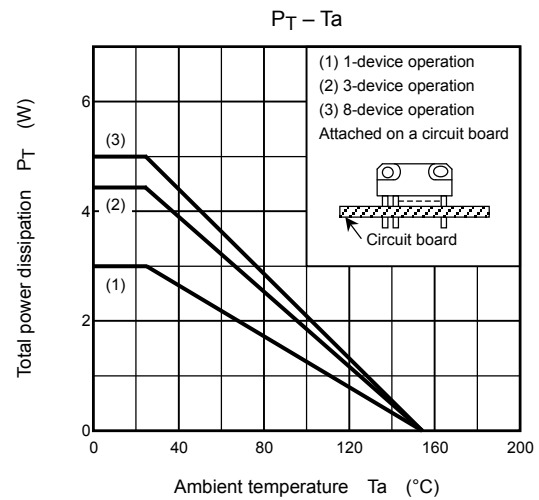
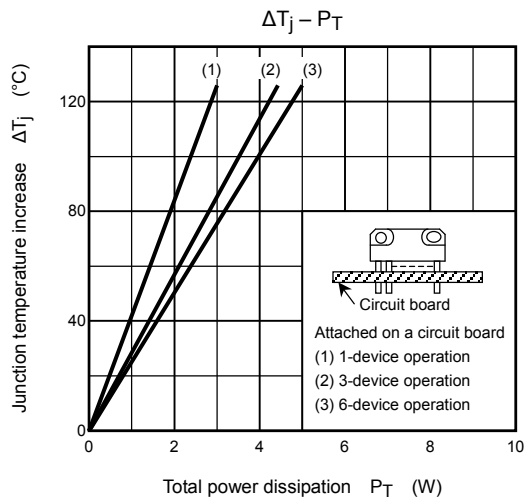
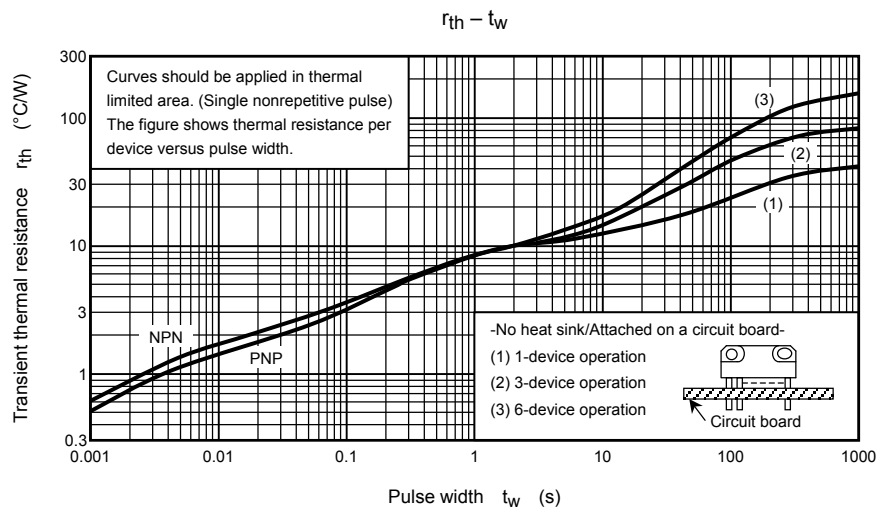
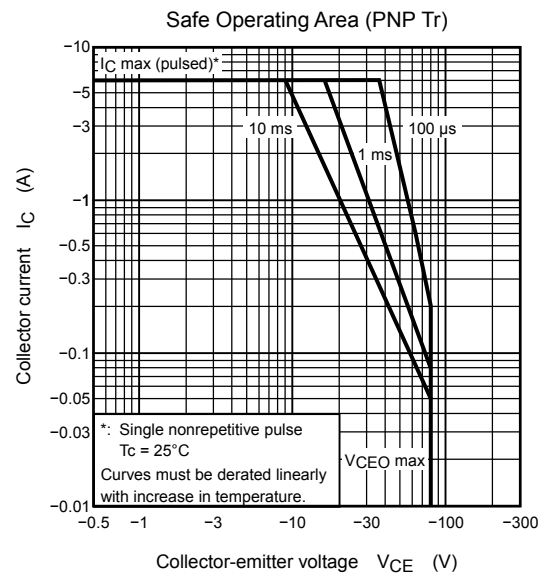
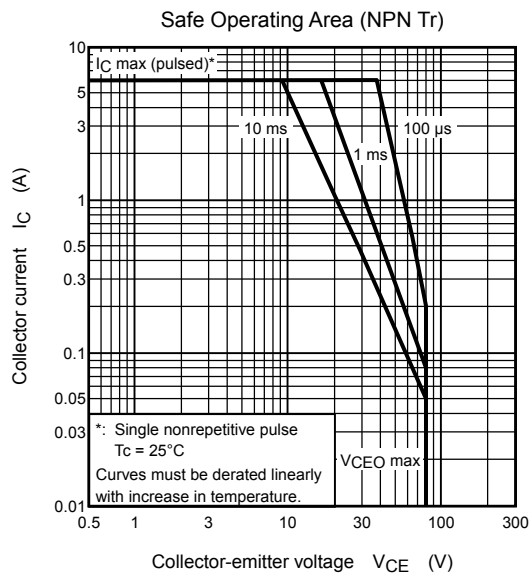
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Forward current	I_{FM}	—	—	—	4	A
Surge current	I_{FSM}	$t = 1 \text{ s}, 1 \text{ shot}$	—	—	6	A
Forward voltage	V_F	$I_F = 1 \text{ A}, I_B = 0 \text{ A}$	—	—	2.0	V
Reverse recovery time	t_{rr}	$I_F = 4 \text{ A}, V_{BE} = 3 \text{ V}, dI_F/dt = -50 \text{ A}/\mu\text{s}$	—	1.0	—	μs
Reverse recovery charge	Q_{rr}		—	8	—	μC

(NPN transistor)



(PNP transistor)





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